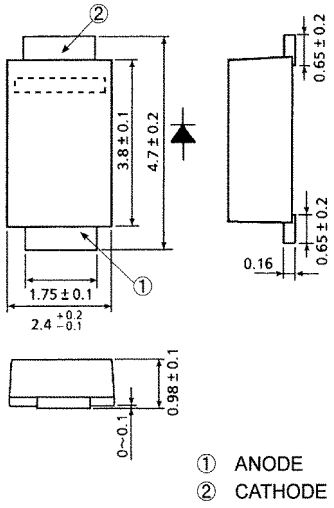
TOSHIBA Schottky Barrier Rectifier Schottky Barrier Type

CMS06

Switching Mode Power Supply Applications
Portable Equipment Battery Applications

- Forward voltage: V_{FM} = 0.37 V (max)
- Average forward current: $I_{F\ (AV)}$ = 2.0 A
- Repetitive peak reverse voltage: V_{RRM} = 30 V
- Suitable for compact assembly due to small surface-mount package "M−FLAT™" (Toshiba package name)

Unit: mm



JEDEC	—
JEITA	—
TOSHIBA	3-4E1A

Weight: 0.023 g (typ.)

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}	30	V
Average forward current	$I_{F\ (AV)}$	2.0 (Note)	A
Peak one cycle surge forward current (non-repetitive)	I_{FSM}	40 (50 Hz)	A
Junction temperature	T_j	−40~125	°C
Storage temperature	T_{stg}	−40~150	°C

Note: $T\ell$ = 82.8°C: Rectangular waveform (α = 180°), V_R = 15 V

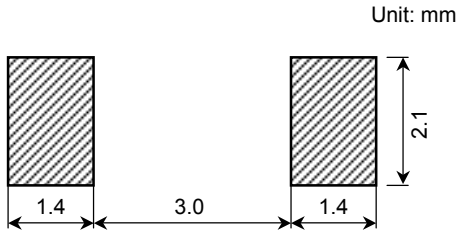
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM\ (1)}$	I_{FM} = 0.5 A	—	0.26	—	V
	$V_{FM\ (2)}$	I_{FM} = 1.0 A	—	0.28	—	
	$V_{FM\ (3)}$	I_{FM} = 2.0 A	—	0.32	0.37	
Repetitive peak reverse current	I_{RRM}	V_{RRM} = 5 V	—	0.09	—	mA
	I_{RRM}	V_{RRM} = 30 V	—	1.4	3.0	
Junction capacitance	C_j	V_R = 10 V, f = 1.0 MHz	—	130	—	pF
Thermal resistance	$R_{th\ (j\text{-}a)}$	Device mounted on a ceramic board (soldering land: 2 mm × 2 mm)	—	—	60	°C/W
		Device mounted on a glass-epoxy board (soldering land: 6 mm × 6 mm)	—	—	135	
Thermal resistance	$R_{th\ (j\text{-}\ell)}$	—	—	—	16	°C/W

Marking

Abbreviation Code	Part No.
S6	CMS06

Standard Soldering Pad



Handling Precaution

Schottky barrier diodes have reverse current characteristic compared to the other diodes.
There is a possibility SBD may cause thermal runaway when it is used under high temperature or high voltage. This device is V_F-I_{RRM} trade-off type, lower V_F higher I_{RRM}; therefore, thermal runaway might occur when voltage is applied. Please take forward and reverse loss into consideration during design.

The maximum ratings denote the absolute maximum ratings, which are rated values and must not be exceeded during operation, even for an instant. The following are the general derating methods that we recommend when you design a circuit with a device.

V_{RRM}: Use this rating with reference to the above. V_{RRM} has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.

$I_{F(AV)}$: We recommend that the worst case current be no greater than 80% of the maximum rating of $I_{F(AV)}$ and T_j be below 100°C. When using this device, take the margin into consideration by using an allowable $T\ell$ max - $I_{F(AV)}$ curve.

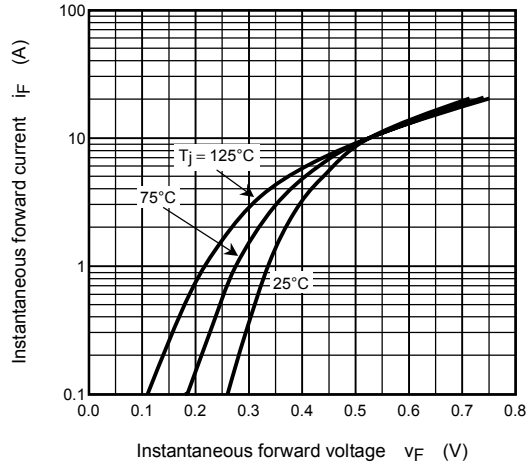
I_{FSM}: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.

T_j: Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_j of below 100°C.

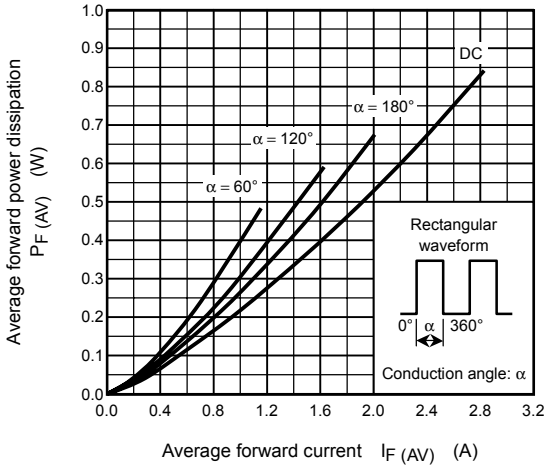
Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, please design a circuit board and a soldering land size to match the appropriate thermal resistance value.

Please refer to the Rectifiers Databook for further information.

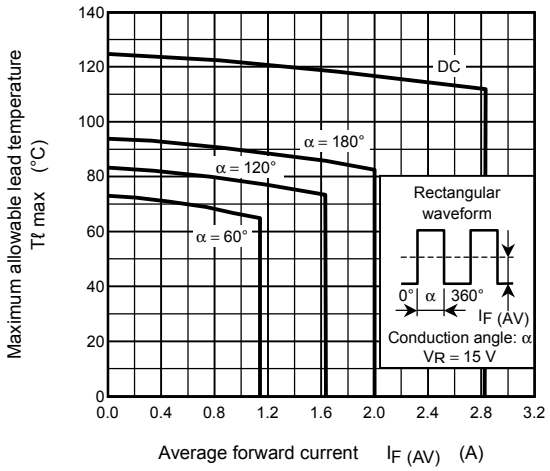
$i_F - v_F$



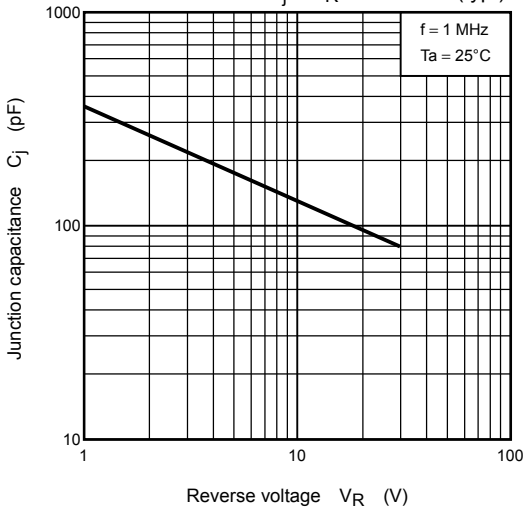
$P_{F\,(AV)} - I_{F\,(AV)}$



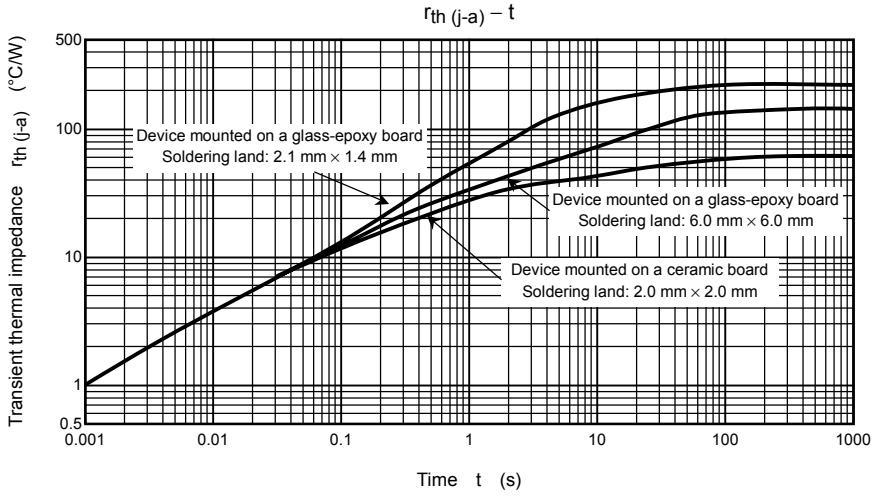
$T\ell\ max - I_{F\,(AV)}$



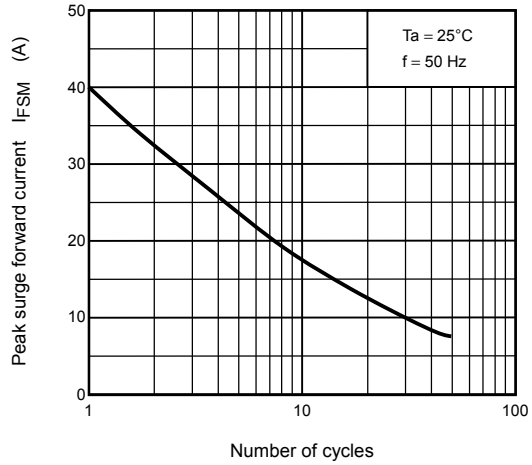
$C_j - V_R$ (typ.)



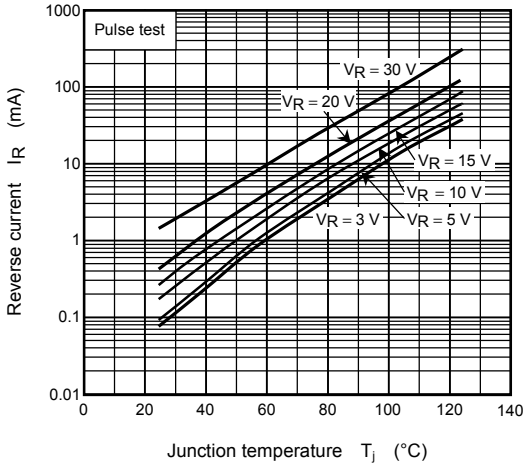
$r_{th\,(j\text{-}a)} - t$



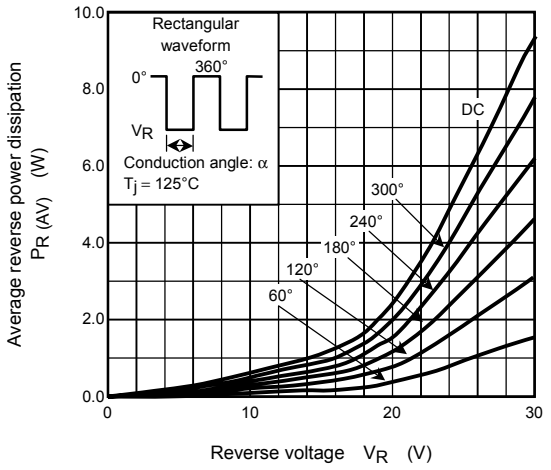
Surge forward current (non-repetitive)



$I_R - T_j$ (typ.)



$P_{R\,(AV)} - V_R$ (typ.)



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